



FINAL POLISHING SYSTEM - 2 -

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<Work 1> Removal of seediness

MODEL U-51

[Specifications]

Model	Speed	Weight	Pad size	Paper size
U-51	8500rpm	480g	30mm	32mm

STANDARD ACCESSORIES:

30mm Velcro Pad Base & 30mm Glue-on Disc

[Applications]

- *Removal of seeding, runs, dust chips, etc. on the painted surface of automobile or motorcycle body and other components.
- *Removal of dust chips for baking-painted electric appliances.

[Features]

- *Removal can be made at the minimum area.
- *Double action prevents deep grinding, that saves the polishing time for finishing work.



<Work 2> Polishing

MODEL U-85V

[Specifications]

Model	Speed	Weight	Pad size	Buffer size
U-85V	3000rpm	1140g	123mm	150mm

STANDARD ACCESSORY:

123mm Velcro Pad

[Applications]

- *For finishing work after removal of seediness.
- *Also ideal for polishing small components, and plastic parts.

[Features]

- *Vertical polishing by two hands shortens operation time.
- *High-torque motor keeps constant speed, that enables smooth polishing even when high pressure is loaded on the pad.



[Optional accessories]

- a) 150mm Buffering Disc
- b) 150mm Buffer
- c) 150mm Urethane Buffer



<Work 3> Final polishing

MODEL U-52

[Specifications]

Model	Speed	Weight	Pad size	Buffer size
U-52	10000rpm	730g	45/72mm	50/80mm

STANDARD ACCESSORIES:

72mm Velcro Pad, 45mm Velcro Pad & 50mm Buffering Disc

[Applications]

- *For cleaning blushed or chalked surface after polishing with U-85V at small area.

[Features]

- *Not only final polishing with buffer, but sanding with abrasive paper.
- *Choose 72mm or 45mm pad for the working area.

[Optional accessories]

-  80mm Thick Buffer
-  80mm Urethane Buffer

